FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

Title of Invention

[FLIP-CHIP PACKAGE SUBSTRATE AND FLIP-CHIP BONDING PROCESS THEREOF]

Application Number:

Date:

First Named Applicant: Mr. Min-Lung Huang

Attorney Docket Number: 10788-US-PA

TOTAL FEE AUTHORIZED \$810

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$				
Utility Filing Fee	1001	770	770				
Subtotal For Basic Filing Fees: \$ 770							

EXTRA CLAIM FEES

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$		
Total Claims: 14	0	1202	18	0		
Independent Claims: 2	0	1201	86	0		
Subtotal For Extra Claims Fees: \$ (

ASSIGNMENT FEES

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$	
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	40	40	
Subtotal For Additional Fees: \$4						

AUTHORIZED BILLING INFORMATION

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Credit account number: 1000

Expiration Date (YYYYMMDD): 2006-10-31

Authorized name: LEE, HUAI-LU

Billing address: 99999